

## TLP176A

PBX  
 Measurement Instrument  
 Data Acquisition  
 Measurement Equipment

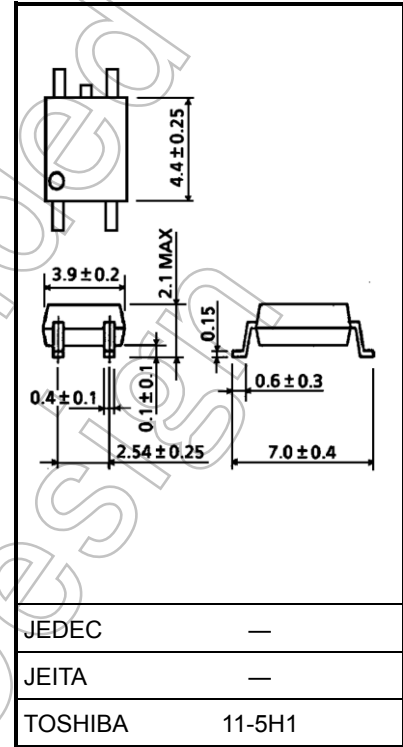
Unit mm

The TOSHIBA TLP176A consists of an infrared emitting diode optically coupled to a photo-MOS FET in a SOP, which is suitable for surface mount assembly.

The TLP176A is suitable for replacement of mechanical relays in many applications which require space savings.

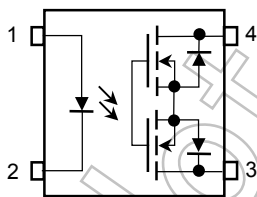
- 4-pin SOP(2.54SOP4)
- Peak off-state voltage : 60V(min)
- Trigger LED current : 3mA(max)
- On-state current : 400mA(max)
- On-state resistance : 2Ω(max)
- Isolation voltage : 1500Vrms(min)
- UL-recognized : UL 1577, File No.E67349
- cUL-recognized : CSA Component Acceptance Service No.5A File No.E67349
  
- VDE-approved : EN 60747-5-5 (Note 1)

Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.



Weight: 0.1 g (typ.)

### Pin Configuration (top view)



- 1. : Anode
- 2. : Cathode
- 3. : Drain
- 4. : Drain

Start of commercial production  
 1998-03

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I <sub>F</sub>	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> / °C	-0.5	mA / °C
	Pulse forward current (100μs pulse, 100pps)	I <sub>FP</sub>	1	A
	Reverse voltage	V <sub>R</sub>	5	V
	Diode power dissipation	P <sub>D</sub>	50	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP <sub>D</sub> / °C	-0.5	mW / °C
	Junction temperature	T <sub>j</sub>	125	°C
Detector	Off-state output terminal voltage	V <sub>OFF</sub>	60	V
	On-state current	I <sub>ON</sub>	400	mA
	On-state current derating (Ta ≥ 25°C)	ΔI <sub>ON</sub> / °C	-4.0	mA / °C
	Output power dissipation	P <sub>O</sub>	180	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP <sub>O</sub> / °C	-1.8	mW / °C
	Junction temperature	T <sub>j</sub>	125	°C
Storage temperature range		T <sub>stg</sub>	-55 to 100	°C
Operating temperature range		T <sub>opr</sub>	-40 to 85	°C
Lead soldering temperature(10 s)		T <sub>sol</sub>	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BVs	1500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pin 1 and 2 shorted together and pin 3 and 4 shorted together.

## Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>DD</sub>	—	—	48	V
Forward current	I <sub>F</sub>	5	7.5	25	mA
On-state current	I <sub>ON</sub>	—	—	300	mA
Operating temperature	T <sub>opr</sub>	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Individual Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V <sub>F</sub> = 0 V, f = 1 MHz	—	30	—	pF
Detector	Off-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 60 V	—	—	1	μA
	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 1 MHz	—	130	—	pF

## Coupled Electrical Characteristics (Ta = 25°C)

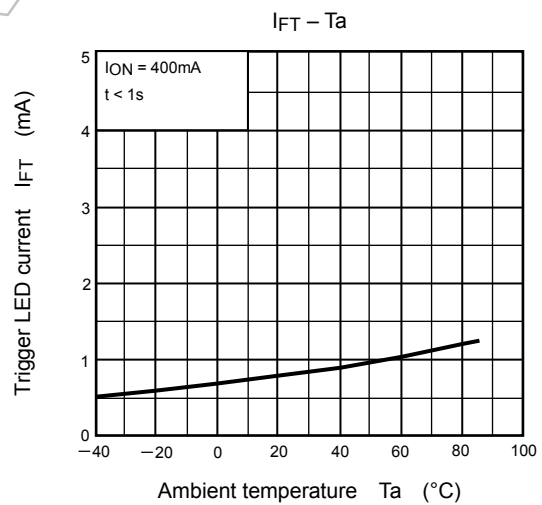
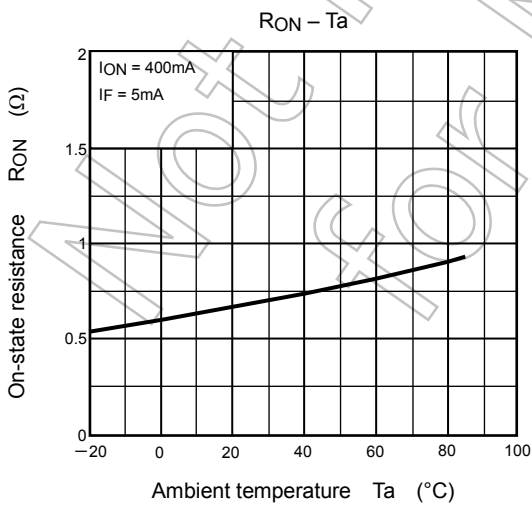
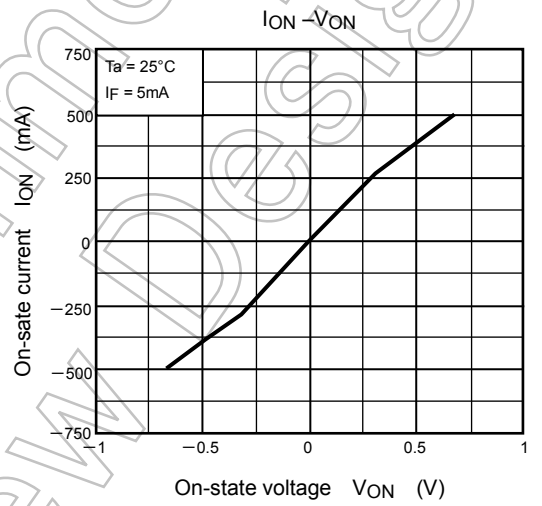
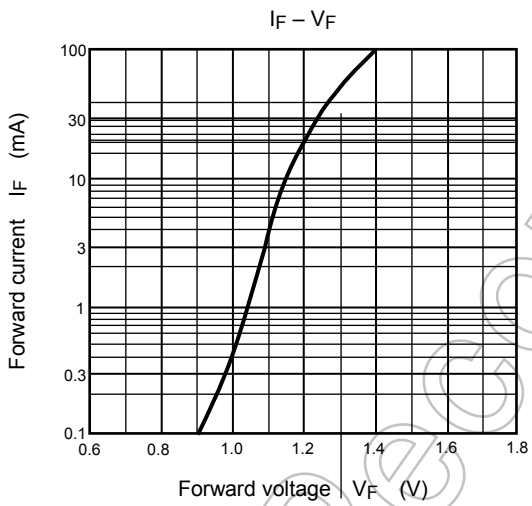
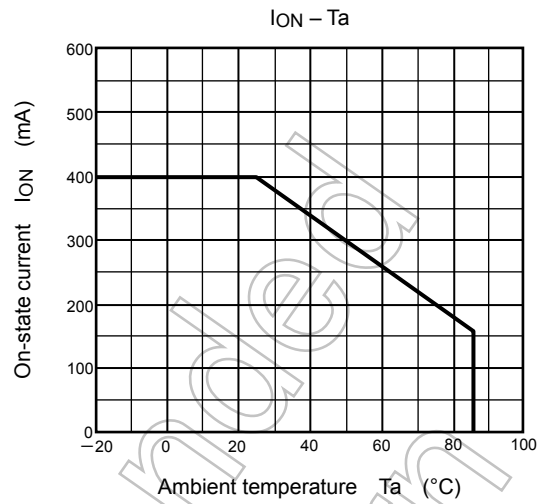
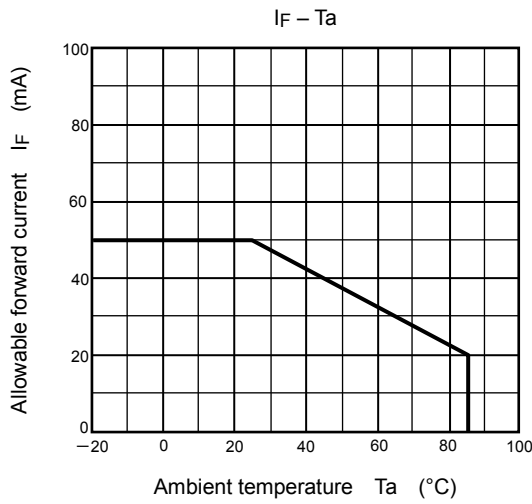
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 400 mA	—	1	3	mA
On-state resistance	R <sub>ON</sub>	I <sub>ON</sub> = 400 mA, I <sub>F</sub> = 5 mA	—	1	2	Ω
Return LED current	I <sub>FC</sub>	I <sub>OFF</sub> = 100 μA	0.1	—	—	mA

## Isolation Characteristics (Ta = 25°C)

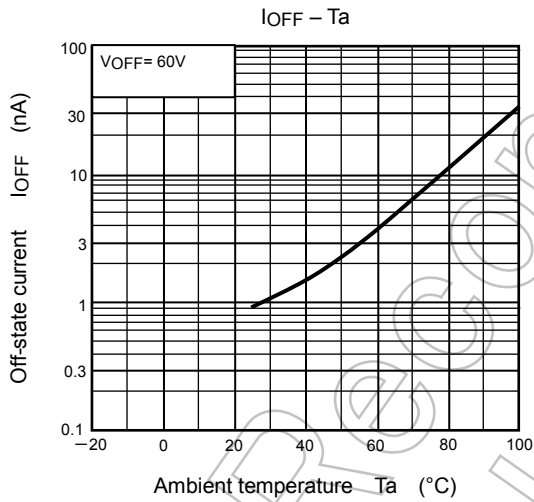
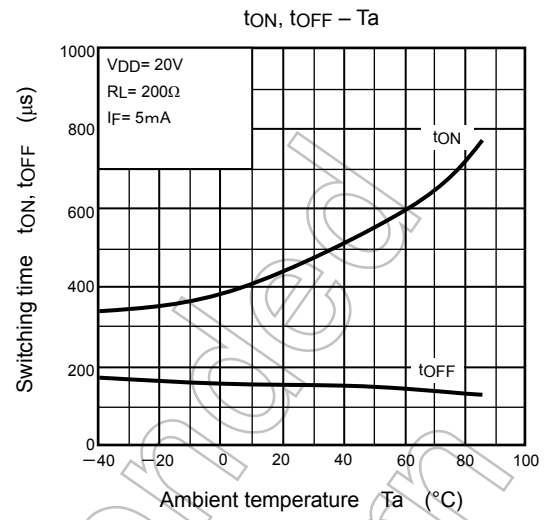
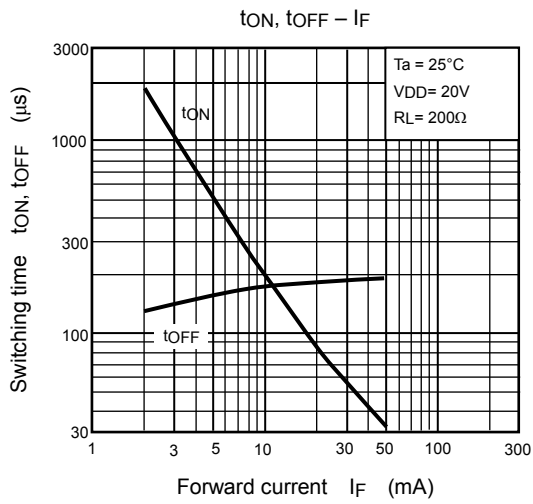
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	B <sub>V<sub>S</sub></sub>	AC, 60 s	1500	—	—	V <sub>rms</sub>

## Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 200 Ω	—	0.6	2	ms
Turn-off time	t <sub>OFF</sub>	V <sub>CC</sub> = 20 V, I <sub>F</sub> = 5 mA	—	0.1	1	



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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